APT30D120SG Datasheet Ultrafast Soft Recovery Rectifier Diode

March 2018





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1 Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

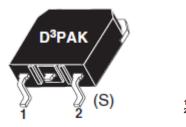
1.1 Revision A

Revision A was published in March 2018. It is the first publication of this document.



2 Product Overview

This section outlines the product overview for the APT30D120SG device.





Back of Case - Cathode

2.1 Features

The following are key features of the APT30D120SG device:

- Ultrafast recovery times
- Soft recovery characteristics
- Low forward voltage
- Low leakage current
- RoHS compliant

2.2 Benefits

The following are benefits of the APT30D120SG device:

- Low switching losses
- Low noise (EMI) switching
- Cooler operation
- Higher reliability systems
- Increased system power density

2.3 Applications

The APT30D120SG device is designed for the following applications:

- Power factor correction (PFC)
- Anti-parallel diode
 - Switchmode power supply
 - Inverters
- Freewheeling diode
 - Motor controllers
 - Converters
 - Inverters
- Snubber diode



3 Electrical Specifications

This section details the electrical specifications for the APT30D120SG device.

3.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings for the APT30D120SG device.

All Ratings: $T_c = 25$ °C unless otherwise specified.

Table 1 • Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
VR	Maximum DC reverse voltage	1200	V
V _{RRM}	Maximum peak repetitive reverse voltage	1200	
V _{RWM}	Maximum working peak reverse voltage	1200	
I _{F(AV)}	Maximum average forward current (TC= 128 °C, duty cycle = 0.5)	30	Α
I _F (RMS)	RMS forward current	59	_
İfsm	Non-repetitive forward surge current (T _J = 45 °C, 8.3 ms)	210	_
Tı, Tstg	Operating and storage temperature range	-55 to	°C
		175	
Tι	Lead temperature for 10 s	300	=

3.2 Typical Electrical Performance

The following table shows the static electrical characteristics of the APT30D120SG device.

Table 2 • Static Electrical Characteristics

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	Unit
	Forward voltage	I _F = 30 A		2.0	2.5	– V
VF		I _F = 60 A		2.3		
		I _F = 30 A, T _J = 125 °C		1.8		-
Irm	Maximum reverse leakage current	$V_R = V_R$ rated			250	μΑ
		V _R = V _R rated, T _J = 125 °C			500	-
Ст	Junction capacitance	V _R = 200 V		32		pF



The following table shows the dynamic characteristics of the APT30D120SG device.

Table 3 • Dynamic Characteristics

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	Unit
trr	Reverse recovery time	$I_F = 1 \text{ A}$ $di_F/dt = -100 \text{ A/}\mu\text{s}$ $V_R = 30 \text{ V}$ $T_J = 25 \text{ °C}$		31		ns
trr	Reverse recovery time	I _F = 30 A		370		-
Qrr	Reverse recovery charge	_ di _F /dt = -200 A/μs _ V _R = 800 V		660		nC
IRRM	Maximum reverse recovery current	Tc = 25 °C		5		Α
trr	Reverse recovery time	I _F = 30 A		500		ns
Qrr	Reverse recovery charge	- di _F /dt = -200 A/μs - V _R = 800 V	-	3450		nC
Irrm	Maximum reverse recovery current	Tc = 125 °C		12		Α
trr	Reverse recovery time	I _F = 30 A		220		ns
Qrr	Reverse recovery charge	di _F /dt = −1000 A/μs V _R = 800 V	-	4650		nC
IRRM	Maximum reverse recovery current	Tc = 125 °C		37		Α

The following table shows the thermal and mechanical characteristics of the APT30D120SG device.

Table 4 • Thermal and Mechanical Characteristics

Symbol	Characteristic/Test Conditions	MIN	TYP	MAX	Unit
Reuc	Junction-to-case thermal resistance			0.61	- °C/W
Rеја	Junction-to-ambient thermal resistance			40	- C/ VV
WT	Package weight		0.14		OZ
			4.0		g



3.3 Typical Performance Curves

This section shows the typical performance curves for the APT30D120SG device.

Figure 1 • Maximum Effective Thermal Impedance, Junction-to-Case vs. Pulse Duration

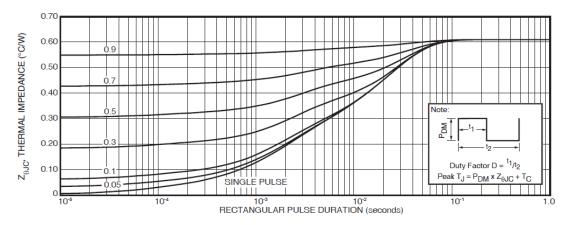


Figure 2 • Transient Thermal Impedance Model

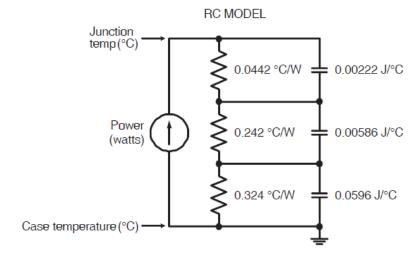




Figure 3 • Forward Current vs. Forward Voltage

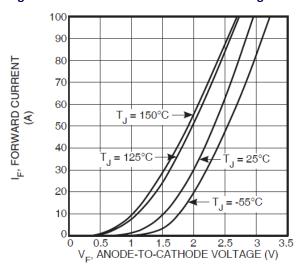


Figure 5 • Qrr vs. Current Rate of Change

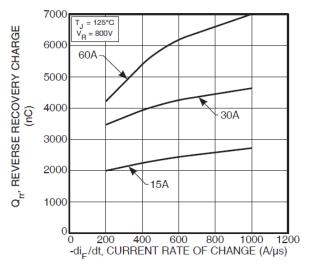


Figure 7 • Dynamic Parameters vs. Junc Temp

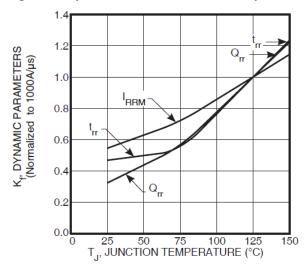


Figure 4 • trr vs. Current Rate of Change

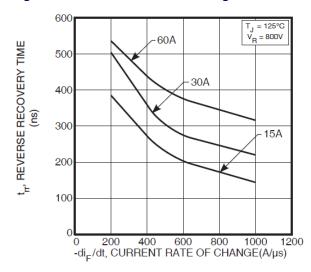


Figure 6 • Irrm vs. Current Rate of Change

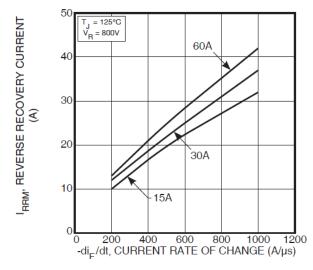


Figure 8 • Max Avg Forward Current vs. Case Temp

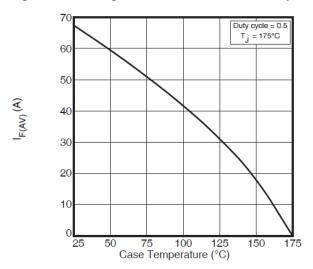
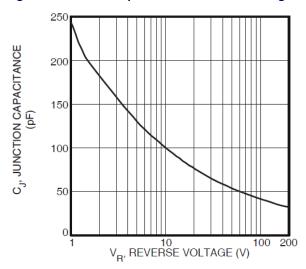




Figure 9 • Junction Capacitance vs. Reverse Voltage





3.4 Reverse Recovery Overview

The following illustration shows the reverse recovery testing and measurement information for the APT30D120SG device.

Figure 10 • Diode Test Circuit

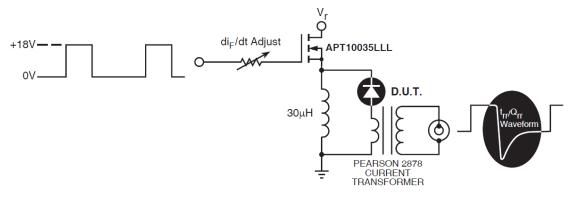
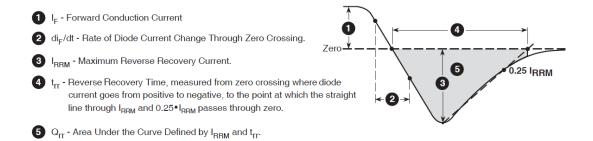


Figure 11 • Diode Reverse Recovery Waveform and Defintions





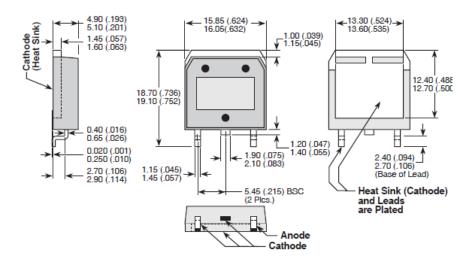
4 Package Specification

This section outlines the package specification for the APT30D120SG device.

4.1 Package Outline Drawing

This section details the D3PAK package drawing of the APT30D120SG device. Dimensions are in millimeters and (inches).

Figure 12 • Package Outline Drawing







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